
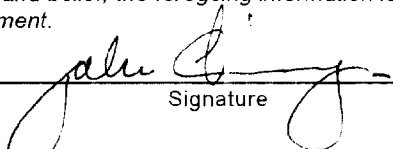


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FORM PTO-1595 1/31/92	<b>RECORDATIC PATENT</b>	12-16-1999  <b>101223277</b>
To the Honorable Commissioner of Patents and Trademark		DEPARTMENT OF COMMERCE Patent and Trademark Office. or copy thereof.
1. Name of conveying party(ies): KAZUMASA NOMOTO DHARAM PAL GOSAIN SETSUO USUI TAKASHI NOGUCHI Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	2. Name and address of receiving party(ies): Name: <u>Sony Corporation</u> Internal Address: _____ _____ Street Address: <u>7-35, Kitashinagawa 6- Chome</u> <u>Shinagawa-Ku</u> City: <u>Tokyo Japan</u> State: _____ Zip: _____ Additional Name(s) & Address(es) attached <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	
3. Nature of conveyance: <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Other _____ Execution Date <u>November 16, 1999</u>		
4. Application (number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: <div style="display: flex; justify-content: space-between;"> <span>A. Patent Application No.(s)</span> <span>B. Patent No (s)</span> </div> <div style="display: flex; justify-content: space-between; margin-top: 10px;"> <span>USSN 09/ 404,479 filed September 24, 1999</span> <span></span> </div> <div style="text-align: center; margin-top: 10px;">         Additional numbers attached?   <input type="checkbox"/> Yes   <input checked="" type="checkbox"/> No       </div>		
5. Name and address of party to whom correspondence concerning document should be mailed: <div style="text-align: center; margin-top: 20px;"> <b>Hill &amp; Simpson, P.C.</b>          85th Floor Sears Tower          233 S. Wacker Drive          Chicago, IL 60606       </div>	6. Total number of applications and patents involved <div style="text-align: right; margin-right: 50px;"> <u>1</u> </div> <div style="margin-top: 10px;">         7. Total Fee (37 CFR 3.41) ..... \$ <u>40.00</u>  <input checked="" type="checkbox"/> Enclosed  <input checked="" type="checkbox"/> Authorized to be charged to deposit account any Additional fees       </div> <div style="margin-top: 10px;">         8. Deposit Account Number:  <u>08-2290</u>  <small>(Attach duplicate copy of this page if paying by deposit account)</small> </div>	
DO NOT USE THIS SPACE		
9. Statement and signature: <i>To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.</i> <div style="display: flex; justify-content: space-between; align-items: flex-end; margin-top: 20px;"> <div style="text-align: center;"> <u>John Simpson</u>          Name of Person Signing       </div> <div style="text-align: center;">           Signature       </div> <div style="text-align: center;"> <u>November 23, 1999</u>          Date       </div> </div> <div style="text-align: right; margin-top: 10px;">         Total number of pages comprising cover sheet: <u>3</u> </div>		
Mail documents to be recorded and required cover sheet information to: <b>Commissioner of Patents and Trademarks</b> <b>Box Assignments</b> <b>Washington, D.C. 20231</b>		

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**PATENT**  
**REEL: 010432 FRAME: 0936**

**ASSIGNMENT**

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in MEMORY DEVICE, MANUFACTURING METHOD THEREOF AND INTEGRATED CIRCUIT THEREOF

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of my Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense.

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/404,479, Filing Date: 9/24/1999

This assignment executed on the dates indicated below.

KAZUMASA NOMOTO

Name of first or sole inventor

Execution date of U.S. Patent Application

KANAGAWA, JAPAN

Residence of first or sole inventor

Kazumasa Nomoto  
Signature of first or sole inventor

November 16, 1999  
Date of this assignment

DHARAM PAL GOSAIN

Name of second inventor

Execution date of U.S. Patent Application

KANAGAWA, JAPAN

Residence of second inventor

*Dharam Pal Gosain*

Signature of second inventor

*November 16, 1999*

Date of this assignment

SETSUO USUI

Name of third inventor

Execution date of U.S. Patent Application

KANAGAWA, JAPAN

Residence of third inventor

*Setsumi Usui*

Signature of third inventor

*November 16, 1999*

Date of this assignment

TAKASHI NOGUCHI

Name of fourth inventor

Execution date of U.S. Patent Application

KANAGAWA, JAPAN

Residence of fourth inventor

*Takashi Noguchi*

Signature of fourth inventor

*Nov 16, 1999*

Date of this assignment

Name of fifth inventor

Execution date of U.S. Patent Application

Residence of fifth inventor

Signature of fifth inventor

Date of this assignment